

500mW 5% Zener Diodes

FEATURES

- Wide zener voltage range selection: 2.4V to 36V
- VZ Tolerance Selection of ± 5%
- Surface device type mountin
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Low voltage stabilzers or voltage references
- Adapters
- Lighting application
- On-board DC/DC converter

MECHANICAL DATA

- Case: 0805
- Molding compound: UL flammability classification rating 94HB
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: Indicated by cathode band
- Weight: 0.006grams (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
V _Z	2.4-36	V				
Test current I _{ZT}	5	mA				
P _{tot}	500	mW				
V _F at I _F =10mA	1.5	V				
T _J Max.	150	°C				
Package	0805					
Configuration	Single dice					







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER SYMBOL PART NUMBER UN						
Forward voltage @ I _F =10mA	V_{F}	1.5	V			
Total power dissipation	P _{tot}	500	mW			
Junction temperature range	T _J	-55 to +150	°C			
Storage temperature range	T _{STG}	-55 to +150	°C			

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient thermal resistance	R _{eJA}	300	°C/W

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			ZENER VOLTAGE		TEST	REGI	REGULAR		LEAKAGE	
PART	MARKING				CURRENT	IMPED	ANCE	CURRENT	CURI	RENT
NUMBER	CODE		V _Z @ I _{ZT}		I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}	I _{ZK}	V _Z @ I _{ZT}	
NOMBER			V	Т	mA	Ω	Ω	mA	μΑ	١
		Min.	Nom.	Max.		Max.	Max.		Max.	
3ZY55C2V4	2V4	2.28	2.40	2.52	5	85	600	1	50	1.
BZY55C2V7	2V7	2.57	2.70	2.84	5	85	600	1	10	1.
BZY55C3V0	3.0	2.85	3.00	3.15	5	85	600	1	4	1.
BZY55C3V3	3V3	3.14	3.30	3.47	5	85	600	1	2	1.
3ZY55C3V6	3V6	3.42	3.60	3.78	5	85	600	1	2	1.
3ZY55C3V9	3V9	3.71	3.90	4.10	5	85	600	1	2	1.
3ZY55C4V3	4V3	4.09	4.30	4.52	5	80	600	1	1	1.
BZY55C4V7	4V7	4.47	4.70	4.94	5	70	600	1	0.5	1.
3ZY55C5V1	5V1	4.85	5.10	5.36	5	50	550	1	0.1	1.
3ZY55C5V6	5V6	5.32	5.60	5.88	5	30	450	1	0.1	1.
BZY55C6V2	6V2	5.89	6.20	6.51	5	10	200	1	0.1	2
BZY55C6V8	6V8	6.46	6.80	7.14	5	8	150	1	0.1	3
BZY55C7V5	7V5	7.13	7.50	7.88	5	7	50	1	0.1	5
BZY55C8V2	8V2	7.79	8.20	8.61	5	7	50	1	0.1	6
BZY55C9V1	9V1	8.65	9.10	9.56	5	10	50	1	0.1	6
BZY55C10	10	9.50	10.00	10.50	5	15	70	1	0.1	7
BZY55C11	11	10.45	11.00	11.55	5	20	70	1	0.1	8
BZY55C12	12	11.40	12.00	12.60	5	20	90	1	0.1	9
BZY55C13	13	12.35	13.00	13.65	5	26	110	1	0.1	1
BZY55C15	15	14.25	15.00	15.75	5	30	110	1	0.1	1
BZY55C16	16	15.20	16.00	16.80	5	40	170	1	0.1	1
BZY55C18	18	17.10	18.00	18.90	5	50	170	1	0.1	1
BZY55C20	20	19.00	20.00	21.00	5	55	220	1	0.1	1
BZY55C22	22	20.90	22.00	23.10	5	55	220	1	0.1	1
BZY55C24	24	22.80	24.00	25.20	5	80	220	1	0.1	1
BZY55C27	27	25.65	27.00	28.35	5	80	220	1	0.1	2
BZY55C30	30	28.50	30.00	31.50	5	80	220	1	0.1	2
BZY55C33	33	31.35	33.00	34.65	5	80	220	1	0.1	2
BZY55C36	36	34.20	36.00	37.80	5	80	220	1	0.1	2

Notes:

- 1. The Zener Voltage (VZ) is tested under pulse condition of 10ms
- 2. The device numbers listed have a standard tolerance on the nomial zener voltage of ±2%
- 3. For detailed information on price, availability and delivery of nominal zener voltages between the voltages shown and tighter voltage tolerances, contact your nearest Taiwan Semiconductor representative
- 4. The zener impedance is derived from the 60-cycle ac voltage, which results when an ac current having an RMS value equal to 10% of the dc zener current(IZT or IZK) is superimposed to IZT or IZK



ORDERING INFORMATION					
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING	
BZY55CXXX (Note 1&2)	RY	G	0005	5K / 7" Reel	
	RB	G	0805	10K / 13" Reel	

Notes:

- 1. "xxx" defines voltage from 2.4V (BZY55C2V4) to 36V (BZY55C36)
- 2. Whole series with green compound

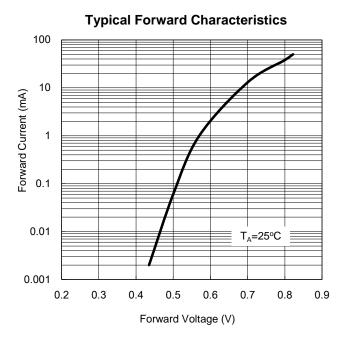
EXAMPLE					
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
BZY55C36 RYG	BZY55C36	RY	G	Green compound	

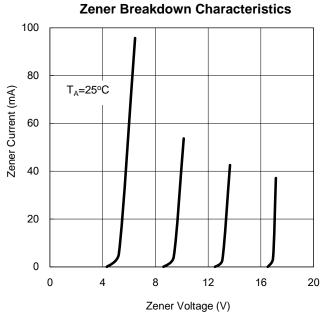


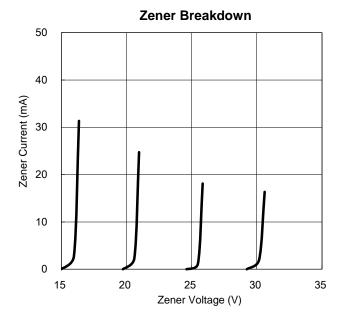


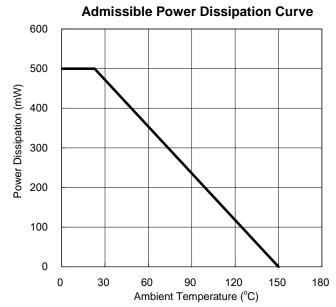
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)





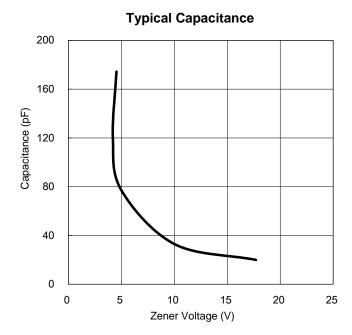


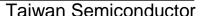




CHARACTERISTICS CURVES

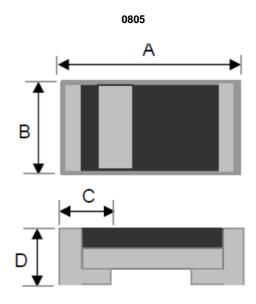
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$





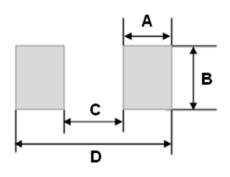


PACKAGE OUTLINE DIMENSION



DIM.	Unit(mm)	Unit(inch)		
DIN.	Min	Max	Min	Max	
Α	1.80	2.20	0.071	0.087	
В	1.05	1.45	0.041	0.057	
С	0.25	0.65	0.010	0.026	
D	0.65	0.85	0.026	0.033	

SUGGEST PAD LAYOUT



рім.	Unit(mm)	Unit(inch)		
DIN.	Тур	Тур		
А	1.10	0.043		
В	1.40	0.055		
С	1.20	0.047		
D	3.40	0.134		



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